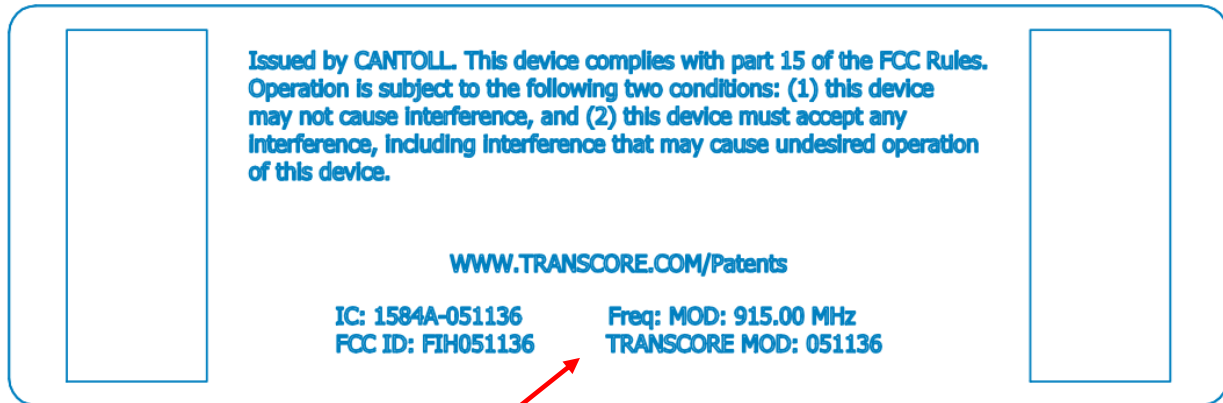


Label Sample and placement (back of device)



FCC and IC Identifiers and HVIN